

2/2/04

	Type	Hits	Search Text	DBs
1	BRS	398	428/67.ccls.	USPAT; US-PGPUB
2	BRS	16	428/67.ccls. and overlay	USPAT; US-PGPUB
3	BRS	132688	microprocessor	USPAT; US-PGPUB
4	BRS	3437	microprocessor and overlay	USPAT; US-PGPUB
5	BRS	103	(microprocessor and overlay) and centerline	USPAT; US-PGPUB
6	BRS	33	((microprocessor and overlay) and centerline) and substrate	USPAT; US-PGPUB
7	BRS	85	(semiconductor adj integrated adj circuit) and overlays	USPAT; US-PGPUB
8	BRS	85	(semiconductor adj integrated adj circuit) and overlays	USPAT; US-PGPUB
9	BRS	85	(semiconductor adj integrated adj circuit) and overlays	USPAT; US-PGPUB
10	BRS	0	((semiconductor adj integrated adj circuit) and overlays ) and post-develop	USPAT; US-PGPUB
11	BRS	1	((semiconductor adj integrated adj circuit) and overlays ) and post-etch	USPAT; US-PGPUB
12	BRS	6	((semiconductor adj integrated adj circuit) and overlays ) and bars	USPAT; US-PGPUB
13	BRS	538	trenches with dielectric adj material	USPAT; US-PGPUB
14	BRS	45	(trenches with dielectric adj material) and overlay	USPAT; US-PGPUB
15	BRS	446	438/16.ccls.	USPAT; US-PGPUB
16	BRS	52	438/16.ccls. and trenches	USPAT; US-PGPUB
17	BRS	446	438/16.ccls. (438/16.ccls. and trenches) and dielectric adj material	USPAT; US-PGPUB
18	BRS	8	(438/16.ccls. and trenches) and dielectric adj material	USPAT; US-PGPUB
19	BRS	701	428/114.ccls.	USPAT; US-PGPUB
20	BRS	1	428/114.ccls. and trenches with dielectric adj material	USPAT; US-PGPUB
21	BRS	2	428/114.ccls. and trenches	USPAT; US-PGPUB
22	BRS	4293	wong.in.	USPAT; US-PGPUB
23	BRS	11	alan same wong.in.	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
24	BRS	15708	semiconductor adj integrated adj circuit	USPAT; US-PGPUB
25	BRS	2055	428/209.ccls.	USPAT; US-PGPUB
26	BRS	217	428/209.ccls. and dielectric adj material	USPAT; US-PGPUB
27	BRS	16	428/209.ccls. and overlays	USPAT; US-PGPUB
28	BRS	1689	428/910.ccls.	USPAT; US-PGPUB
29	BRS	3	428/910.ccls. and overlays	USPAT; US-PGPUB
30	BRS	0	overlay adj trenches	USPAT; US-PGPUB
31	BRS	198	overlays and trenches	USPAT; US-PGPUB
32	BRS	92905	wafer	USPAT; US-PGPUB
33	BRS	18511	wafer and polysilicon	USPAT; US-PGPUB
34	BRS	6157	(wafer and polysilicon) and silicon adj oxide	USPAT; US-PGPUB
35	BRS	6157	((wafer and polysilicon) and silicon adj oxide) and silicon	USPAT; US-PGPUB
36	BRS	3205	((((wafer and polysilicon) and silicon adj oxide) and silicon) and photoresist	USPAT; US-PGPUB
37	BRS	677	(((((wafer and polysilicon) and silicon adj oxide) and silicon) and photoresist) and dielectric adj material	USPAT; US-PGPUB
38	BRS	3	((((((wafer and polysilicon) and silicon adj oxide) and silicon) and photoresist) and dielectric adj material) and trenches) and overlays	USPAT; US-PGPUB
39	BRS	253	((((((wafer and polysilicon) and silicon adj oxide) and silicon) and photoresist) and dielectric adj material) and trenches	USPAT; US-PGPUB
40	BRS	2	((((((wafer and polysilicon) and silicon adj oxide) and silicon) and photoresist) and dielectric adj material) and trenches) and centerline	USPAT; US-PGPUB
41	BRS	1	Embedded adj overlay adj structure	USPAT; US-PGPUB
42	BRS	88	overlay adj measurement	USPAT; US-PGPUB
43	BRS	80	(overlay adj measurement) and semiconductor	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
44	BRS	258	438/975.ccls.	USPAT; US-PGPUB
45	BRS	307	257/797.ccls.	USPAT; US-PGPUB
46	BRS	266	257/797.ccls. not 438/975.ccls.	USPAT; US-PGPUB
47	BRS	15726	semiconductor adj integrated adj circuit	USPAT; US-PGPUB
48	BRS	0	(semiconductor adj integrated adj circuit ) and overlay adj analysis	USPAT; US-PGPUB
49	BRS	85	(semiconductor adj integrated adj circuit ) and overlays	USPAT; US-PGPUB
50	BRS	13169	trenches	USPAT; US-PGPUB
51	BRS	2508	trenches and dielectric adj material	USPAT; US-PGPUB
52	BRS	20	((trenches and dielectric adj material) and transparent adj material) and holes	USPAT; US-PGPUB
53	BRS	11	((((trenches and dielectric adj material) and transparent adj material) and holes) and opaque	USPAT; US-PGPUB
54	BRS	33	(trenches and dielectric adj material) and transparent adj material	USPAT; US-PGPUB
55	BRS	480376	holes	USPAT; US-PGPUB
56	BRS	2367	holes and opaque adj material	USPAT; US-PGPUB
57	BRS	0	(holes and opaque adj material) and semiconductor adj intergrated adj circuit	USPAT; US-PGPUB
58	BRS	482	(holes and opaque adj material) and semiconductor	USPAT; US-PGPUB
59	BRS	4363	trenches and silicon adj dioxide	USPAT; US-PGPUB
60	BRS	833	trenches with silicon adj dioxide	USPAT; US-PGPUB
61	BRS	731	trenches with silicon adj dioxide	USPAT
62	BRS	685	(trenches with silicon adj dioxide) and semiconductor	USPAT
63	BRS	199	trenches and overlays	USPAT; US-PGPUB
64	BRS	108	(trenches and overlays) and silicon adj dioxide	USPAT; US-PGPUB
65	BRS	15726	semiconductor adj integrated adj circuit	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
66	BRS	3	(semiconductor adj integrated adj circuit ) and holes with opaque adj material	USPAT; US-PGPUB
67	BRS	1	(semiconductor adj integrated adj circuit ) and holes adj filled with opaque adj material	USPAT; US-PGPUB
68	BRS	5	holes same filled with opaque adj material	USPAT; US-PGPUB
69	BRS	1	5654070.pn.	USPAT; US-PGPUB
70	BRS	1	6368921.pn.	USPAT; US-PGPUB
71	BRS	8	("4767722"   "4824797"   "5082795"   "5378655"   "5972741"   "6087224"   "6211018"   "6228698").PN.	USPAT
72	BRS	4511	trenches and dielectric adj material	USPAT; US-PGPUB
73	BRS	79	(trenches and dielectric adj material) and holes and opaque	USPAT; US-PGPUB
74	BRS	1423	trenches same dielectric adj material	USPAT; US-PGPUB
75	BRS	975	trenches with dielectric adj material	USPAT; US-PGPUB
76	BRS	43	(trenches with dielectric adj material) and overlay	USPAT; US-PGPUB
77	BRS	44	overlay with trenches	USPAT; US-PGPUB
78	BRS	0	overlapping with trenches	USPAT; US-PGPUB
79	BRS	0	overlapping adj trenches	USPAT; US-PGPUB
80	BRS	0	overlapping same trenches	USPAT; US-PGPUB
81	BRS	374	overlap same trenches	USPAT; US-PGPUB
82	BRS	441	428/67.ccls.	USPAT; US-PGPUB
83	BRS	2	428/67.ccls. and trenches	USPAT; US-PGPUB
84	BRS	4656	holes and opaque adj material	USPAT; US-PGPUB
85	BRS	311	holes with opaque adj material	USPAT; US-PGPUB
86	BRS	21	(holes with opaque adj material) and overlay	USPAT; US-PGPUB
87	BRS	65	(holes with opaque adj material) and semiconductor	USPAT; US-PGPUB
88	BRS	17	(holes with opaque adj material) and microprocessor	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
89	BRS	41	(holes with opaque adj material) and dielectric	USPAT; US-PGPUB
90	BRS	0	opaque adj material adj in adj holes	USPAT; US-PGPUB
91	BRS	76	dark adj holes	USPAT; US-PGPUB
92	BRS	3	(dark adj holes) and dielectric	USPAT; US-PGPUB
93	BRS	1703	filled adj holes	USPAT; US-PGPUB
94	BRS	10	(filled adj holes) and opaque adj material	USPAT; US-PGPUB
95	BRS	3	opaque same filled adj holes	USPAT; US-PGPUB
96	BRS	0	opaque adj material adj filled adj holes	USPAT; US-PGPUB
97	BRS	0	opaque adj material same filled adj holes	USPAT; US-PGPUB
98	BRS	2	holes adj filled with opaque adj material	USPAT; US-PGPUB
99	BRS	0	holes adj filled with dark adj material	USPAT; US-PGPUB
100	BRS	2106	holes adj filled with material	USPAT; US-PGPUB
101	BRS	10	(holes adj filled with material) same opaque	USPAT; US-PGPUB
102	BRS	229040 5	holes adj filled with nontransparent material	USPAT; US-PGPUB
103	BRS	0	holes adj filled with nontransparent adj material	USPAT; US-PGPUB
104	BRS	0	holes adj filled with dark adj material	USPAT; US-PGPUB
105	BRS	0	holes adj filled with black adj material	USPAT; US-PGPUB
106	BRS	0	holes adj filled with thick adj material	USPAT; US-PGPUB
107	BRS	2106	holes adj filled with material	USPAT; US-PGPUB
108	BRS	1	(holes adj filled with material) and nontransparent	USPAT; US-PGPUB
109	BRS	0	(holes adj filled with material) and nonpermable	USPAT; US-PGPUB
110	BRS	2	(holes adj filled with material) and nonpermeable	USPAT; US-PGPUB
111	BRS	1709	428/131.ccls.	USPAT; US-PGPUB
112	BRS	8	428/131.ccls. and opaque adj material	USPAT; US-PGPUB
113	BRS	19	428/131.ccls. and holes adj filled	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
114	BRS	4	opaque adj polysilicon	USPAT; US-PGPUB
115	BRS	26	transparent adj polysilicon	USPAT; US-PGPUB
116	BRS	25	polysilicon adj transparent	USPAT; US-PGPUB
117	BRS	1423	trenches same dielectric adj material	USPAT; US-PGPUB
118	BRS	975	trenches with dielectric adj material	USPAT; US-PGPUB
119	BRS	62	(trenches with dielectric adj material) and transparent	USPAT; US-PGPUB
120	BRS	37	(trenches with dielectric adj material) and opaque	USPAT; US-PGPUB
121	BRS	43	(trenches with dielectric adj material) and overlay	USPAT; US-PGPUB
122	BRS	3	("5276337"   "5345085"   "5701013").PN.	USPAT
123	BRS	0	6407396.URPN.	USPAT
124	BRS	0	6407396.URPN.	USPAT
125	BRS	488	plasma adj nitride	USPAT; US-PGPUB
126	BRS	1	plasma adj nitride with transparent	USPAT; US-PGPUB
127	BRS	0	plasma adj nitride with opaque	USPAT; US-PGPUB
128	BRS	385	trenches and polysilicon and silicon adj dioxide and transparent	USPAT; US-PGPUB
129	BRS	82	trenches with dielectric and polysilicon and silicon adj dioxide and transparent	USPAT; US-PGPUB
130	BRS	0	428/195.ccls.	USPAT; US-PGPUB
131	BRS	2968	428/195.1.ccls.	USPAT; US-PGPUB
132	BRS	114	428/195.1.ccls. and overlay	USPAT; US-PGPUB